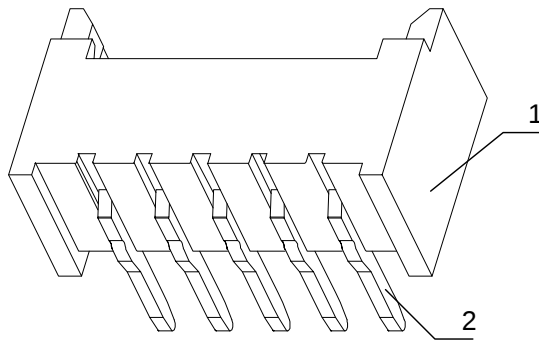
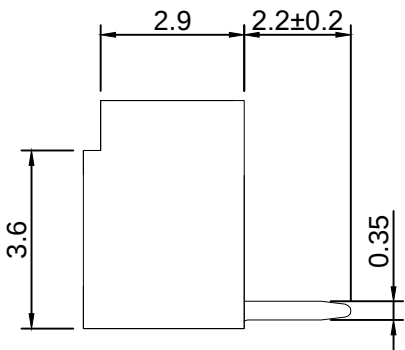
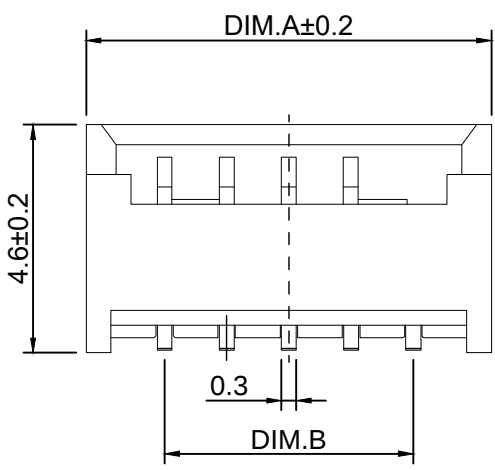
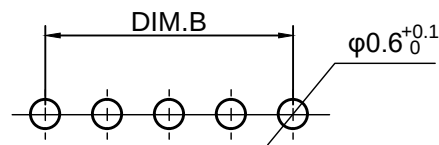
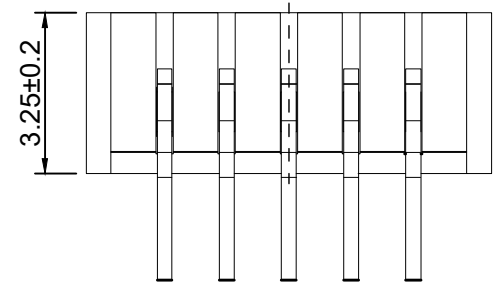


REV.	EC#	DESCRIPTION	DATE	DRAWN	CHECK	APPROVED
1.00		行发版初	2018-04-22			



16	21.9	19.00
15	20.65	17.50
14	19.4	16.25
13	18.15	15.00
12	16.9	13.75
11	15.65	12.50
10	14.4	11.25
9	13.15	10.00
8	11.9	8.75
7	10.65	7.50
6	9.4	6.25
5	8.15	5.00
4	6.9	3.75
3	5.65	2.50
2	4.4	1.25
Pin	DIM.A	DIM.B



PCB LAYOUT

温度范围：-25℃~85℃
额定电压：125V AC/DC
额定电流：1A AC/DC
接触电阻：≤0.02Ω
绝缘电阻：≥1000MΩ
耐 压 值：500V AC/minute
适用基板厚度：1.6mm

2	PIN	n PCS	材质:黄铜, 电镀:镀亮锡
1	Housing	1 PCS	材质:PA6T (UL94V-0), 颜色:本色或黑色
NO.	NAME	QTY	DESCRIPTION

东莞市文章济美电子有限公司

DRAW :		2018-04-22	TITLE: 1.25WDIP CONNWAFER		DRAW NAME: G011-5001-WF0125D-07P1-01-B		
DESIGN:		2018-04-22					
CHECK:		2018-04-22	SERIES: 12502 SERIES		DRAW NO.		
APPROVED		2018-04-22	P/N:				
CUSTOMER DRAWING			REV. 1.00	SCALE N/A	UNIT: mm	SHEET: 1/1	

GENERAL TOLERANCES			
DIM	TOL	DIM DEG	
X.		X°.	±3.00°
X.X	±0.35	X.X°	±2.00°
X.XX	±0.25	X.XX°	±1.00°
X.XXX	±0.15	X.XXX°	

技术要求:

- 1) 材质:见附表;
- 2) 电镀:见附表;
- 3) 塑件表面平整、光洁、无毛刺、气泡、烧焦、变形、浇口无拉伤、多料或缺料等不良现象;
- 4) 端子表面无氧化、电镀不良等现象。